

# CGD982HCI,112 Datasheet



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DiGi Electronics Part Number	CGD982HCI,112-DG
Manufacturer	<a href="#">NXP USA Inc.</a>
Manufacturer Product Number	CGD982HCI,112
Description	IC AMP CATV PWR DOUBLER SOT115J
Detailed Description	Video Amp



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## Purchase and inquiry

Manufacturer Product Number:

CGD982HCI,112

Series:

\*

Base Product Number:

CGD98

Manufacturer:

NXP USA Inc.

Product Status:

Obsolete

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.33.0001

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

# CGD982HCI

## 1 GHz, 22 dB gain GaAs high output power doubler

Rev. 1 — 3 March 2011

Product data sheet

## 1. Product profile

### 1.1 General description

Hybrid amplifier module in a SOT115J package, operating at a supply voltage of 24 V Direct Current (DC), employing Hetero junction Field Effect Transistor (HFET) GaAs dies.

### 1.2 Features and benefits

- Excellent linearity
- Optimized for flat PAL D and flat NTSC loading
- Superior levels of ESD protection
- Extremely low noise
- Excellent return loss properties
- Gain compensation over temperature
- Rugged construction
- Unconditionally stable
- Thermally optimized design
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)
- Integrated ring wave surge protection

### 1.3 Applications

- CATV systems operating in the 40 MHz to 862 MHz / 1003 MHz frequency range using PAL D or NTSC channel conditions.

### 1.4 Quick reference data

**Table 1. Quick reference data**

Bandwidth 40 MHz to 1003 MHz;  $V_B = 24$  V (DC);  $Z_S = Z_L = 75$   $\Omega$ ;  $T_{mb} = 35$  °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$G_p$	power gain	$f = 50$ MHz	-	21.5	-	dB
		$f = 1003$ MHz	22	23	24	dB
CTB	composite triple beat	$V_o = 48$ dBmV at 862 MHz	[1]	-	-66	-62 dBc
CSO	composite second-order distortion	$V_o = 48$ dBmV at 862 MHz	[1]	-	-69	-62 dBc
$I_{tot}$	total current		[2]	-	440	460 mA

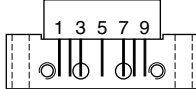
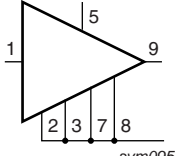
[1] 98 PAL D channels with 8 MHz bandwidth per channel; [ $f = 47$  MHz to 862 MHz]; flat  $V_o$  till 862 MHz.

[2] Direct Current (DC).



## 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	input		
2, 3	common		
5	+V <sub>B</sub>		
7, 8	common		
9	output		

## 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
CGD982HCl	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit	
V <sub>B</sub>	supply voltage		-	30	V	
V <sub>i(RF)</sub>	RF input voltage	single tone	-	75	dBmV	
V <sub>ESD</sub>	electrostatic discharge voltage	Human Body Model (HBM); According JEDEC standard 22-A114E	[1]	-	2000	V
		Biased; According IEC61000-4-2	-	1500	V	
T <sub>stg</sub>	storage temperature		-40	+100	°C	
T <sub>mb</sub>	mounting base temperature		-20	+100	°C	

[1] The ESD pulse of 2000 V corresponds to a class 2 sensitivity level.

## 5. Characteristics

**Table 5. Characteristics**

Bandwidth 40 MHz to 1003 MHz;  $V_B = 24$  V (DC);  $Z_S = Z_L = 75 \Omega$ ;  $T_{mb} = 35$  °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$G_p$	power gain	$f = 50$ MHz	-	21.5	-	dB
		$f = 870$ MHz	-	22.5	-	dB
		$f = 1003$ MHz	22	23	24	dB
$SL_{sl}$	slope straight line	$f = 40$ MHz to 1003 MHz	[1]	0.5	-	2 dB
FL	flatness of frequency response	$f = 40$ MHz to 1003 MHz	[2]	-	-	1 dB
$RL_{in}$	input return loss	$f = 40$ MHz to 160 MHz	20	-	-	dB
		$f = 160$ MHz to 320 MHz	20	-	-	dB
		$f = 320$ MHz to 640 MHz	19	-	-	dB
		$f = 640$ MHz to 870 MHz	17	-	-	dB
		$f = 870$ MHz to 1003 MHz	16	-	-	dB
$RL_{out}$	output return loss	$f = 40$ MHz to 160 MHz	20	-	-	dB
		$f = 160$ MHz to 320 MHz	20	-	-	dB
		$f = 320$ MHz to 640 MHz	19	-	-	dB
		$f = 640$ MHz to 870 MHz	18	-	-	dB
		$f = 870$ MHz to 1003 MHz	17	-	-	dB
NF	noise figure	$f = 50$ MHz	-	4.6	5.6	dB
		$f = 1003$ MHz	-	5.5	6.5	dB
$I_{tot}$	total current		[3]	-	440	460 mA

[1]  $G_p$  at 1003 MHz minus  $G_p$  at 40 MHz.

[2] Flatness is defined as peak deviation to straight line.

[3] Direct Current (DC).

**Table 6. Distortion characteristics**Bandwidth 40 MHz to 1003 MHz;  $V_B = 24$  V (DC);  $Z_S = Z_L = 75 \Omega$ ;  $T_{mb} = 35$  °C; unless otherwise specified.

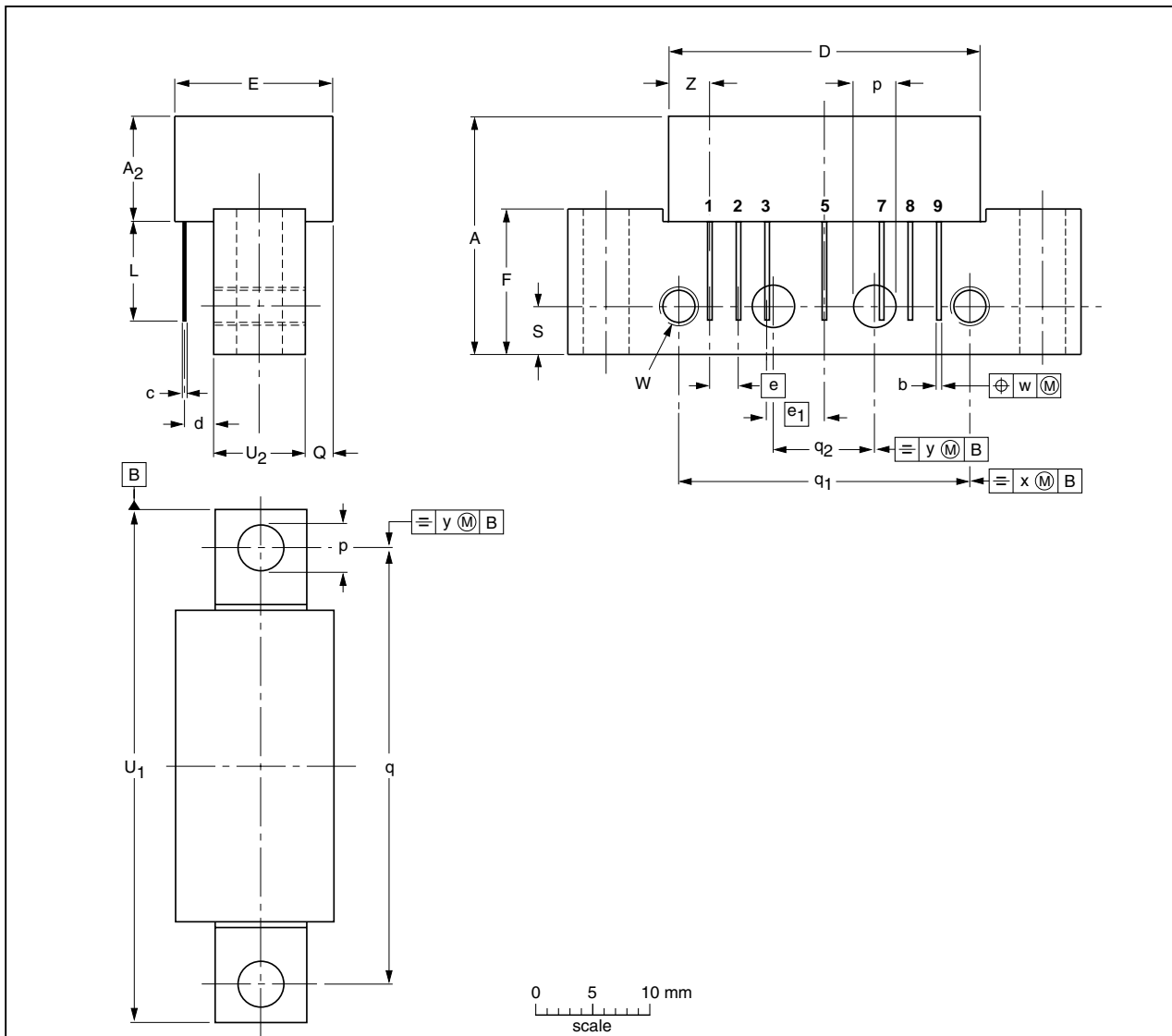
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>98 PAL D channels</b>						
CTB	composite triple beat	$V_o = 48$ dBmV at 862 MHz	[1]	-	-66	-62 dBc
		$V_o = 50$ dBmV at 862 MHz	[1]	-	-62	- dBc
CSO	composite second-order distortion	$V_o = 48$ dBmV at 862 MHz	[1]	-	-69	-62 dBc
		$V_o = 50$ dBmV at 862 MHz	[1]	-	-65	- dBc
Xmod	cross modulation	$V_o = 48$ dBmV at 862 MHz	[1]	-	-68	- dB
		$V_o = 50$ dBmV at 862 MHz	[1]	-	-60	- dB
<b>112 NTSC channels</b>						
CTB	composite triple beat	$V_o = 48$ dBmV at 750 MHz	[2]	-	-63	- dBc
CSO	composite second-order distortion	$V_o = 48$ dBmV at 750 MHz	[2]	-	-66	- dBc
Xmod	cross modulation	$V_o = 48$ dBmV at 750 MHz	[2]	-	-66	- dB
<b>79 NTSC channels + 75 digital channels</b>						
CTB	composite triple beat	$V_o = 56.4$ dBmV at 1003 MHz	[3]	-	-75	- dBc
CSO	composite second-order distortion	$V_o = 56.4$ dBmV at 1003 MHz	[3]	-	-77	- dBc
Xmod	cross modulation	$V_o = 56.4$ dBmV at 1003 MHz	[3]	-	-68	- dB
CCN	carrier-to-composite noise	$V_o = 56.4$ dBmV at 1003 MHz	[3]	-	57	- dBc

[1] 98 PAL D channels with 8 MHz bandwidth per channel;  $[f = 47$  MHz to 862 MHz]; flat  $V_o$  till 862 MHz.[2] 112 NTSC channels;  $[f = 45$  MHz to 750 MHz]; flat  $V_o$  till 750 MHz.[3] 79 NTSC channels  $[f = 54$  MHz to 550 MHz] + 75 digital channels  $[f = 550$  MHz to 1003 MHz] (-6 dB offset); tilt extrapolated to 13.5 dB at 1003 MHz.

6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>2</sub> max.	b	c	D max.	d	E max.	e	e <sub>1</sub>	F	L min.	p	Q max.	q	q <sub>1</sub>	q <sub>2</sub>	S	U <sub>1</sub>	U <sub>2</sub>	W	w	x	y	Z max.
mm	20.8	9.5	0.51 0.38	0.25	27.2	2.04 2.54	13.75	2.54	5.08	12.7	8.8	4.15 3.85	2.4	38.1	25.4	10.2	4.2	44.75 44.25	8.2 7.8	6-32 UNC	0.25	0.7	0.1	3.8

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT115J						-04-02-04- 10-06-18

Fig 1. Package outline SOT115J

## 7. Abbreviations

**Table 7. Abbreviations**

Acronym	Description
CATV	Community Antenna TeleVision
ESD	ElectroStatic Discharge
GaAs	Gallium-Arsenide
NTSC	National Television Standard Committee
PAL D	Phase Alternate Line standard D
RF	Radio Frequency
UNC	UNified Coarse

## 8. Revision history

**Table 8. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
CGD982HCl v.1	20110303	Product data sheet	-	-



## 9. Legal information

### 9.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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